Series MS mini SNAP



Through-beam sensors MSS/MSE

Tiny – great – sensors to simply snap-in



High functionality

Enormeous range

Thanks to most modern electronics and high quality optics for both, the emitter and the receiver a huge range and high signal reserve is achieved.

Fully integrated amplifier

The complete electronics is packed into the emitter and receiver housing. An external amplifier is not required. The sensors are directly connected to the control unit.

High switching frequency

The miniSNAP has a high switching frequency allowing reliable detection of even fast events.

Low power consumption

Although the optical performance is high, the power consumption is very low.

Test input

The emitter has a test input as standard. Herewith the emitter beam can be switched on and off by a control signal. This allows the functional check of the complete light barrier during operation. Also, via the test input multiple miniSNAP sensors can be controlled in multiplex operation.

Power-up output suppression

During power-up the outputs of the miniSNAP sensors are blocked for typically 90 msec.

Simple installation and operation

"Snap-in" mounting concept

The miniSNAP sensor is just pushed into a hole (snap-in) and directly connected to the control unit. The thickness of the mounting plate can vary from 1 to 6 mm. Alignment and adjustment is not necessary. A removal without damaging the sensor is possible with suitable tooling only. The cable exit of emitter and receiver has different colors. It is very flexible and allows optimal adaptation to all mounting conditions.



Optimized emitting and receiving characteristics

The characteristics of the light beam and the response behaviour of the receiver allow slightly displacement or tilt of the sensors. This makes the sensor installation uncritically.

Various connection versions

The miniSNAP is available standard with a 2 m cable or with a 3-pol M8 connector (on cable)

Reliability for the highest demands

Robust construction with IP 67 sealing

The single-part housing is made from robust polyamide 12 and the electronics is densely encapsulated. This makes the miniSNAP insensitive to vibrations, temperature, dust and wetness.

Dirt-repellent front, protected optics

The front part is slightly curved and dirtrepellent. Deposition of residues is only hardly possible. Therefore, high reliability is given even under harsh conditions. The optics is well protected against mechanical damage.

EMC-tested

The miniSNAP sensors are tested according to EN 60947-5-2 and EN 61000-6-1/3/4. This assures trouble free use even in high electromagnetically contaminated environments.

High ambient light rejection

Thanks to pulse modulation and a very sensitive ambient light suppression with active disturbing light recognition and rejection, the miniSNAP sensors are extremely insensitive to foreign light sources e.g. HF-lamps, etc.

Reverse polarity protection

All of the *mini*SNAP sensor's electrical connections are protected against reverse wiring.

Short-circuit protection

The miniSNAP sensor's transistor outputs are electronically protected against short circuit.

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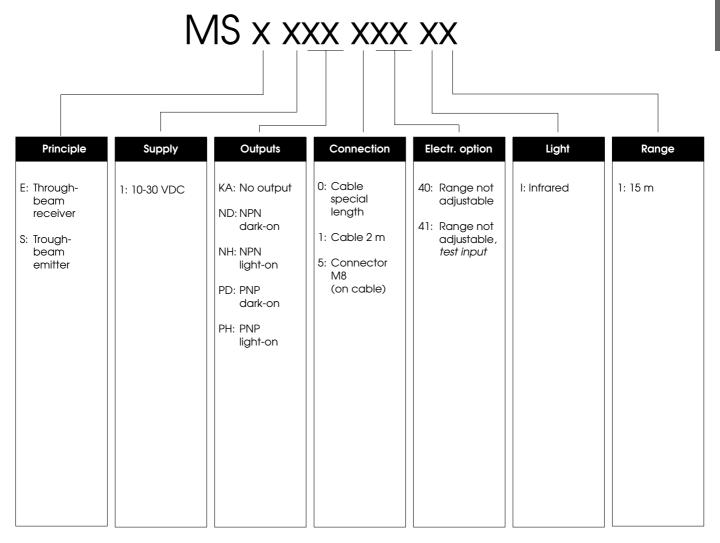


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Designation code



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Through-beam sensors mini SNAP, snap-in housing



- Simplest and quick snap-in mounting
- Fully integrated electronics in emitter and receiver
- Transistor output PNP or NPN, light-on or dark-on
- Test input
- Insensitive to foreign light sources, e.g. HF-lamps, etc.
- Short-circuit protection, reverse polarity protection and power-up output suppression
- Connection: Cable, 2 meter Connector M8 on cable, 3 pin
- EMC-tested according to EN 60947-5-2, EN 61000-6-1/3/4

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Product designation Cable 2 m $^{1)}$	Emitter	Receiver					
	MSS 1KA 141 I1	MSE 1NH 140 I1	MSE 1ND 140 I1	MSE 1PH 140 1	MSE 1PD 140 1		
Product designation Connector M8 ¹⁾	MSS 1KA 541 11	MSE 1NH 540 1	MSE 1ND 540 I1	MSE 1PH 540 I1	MSE 1PD 540 11		
Output		NPN, light-on	NPN, dark-on	PNP, light-on	PNP, dark-or		
Range adjustment	No	No					
Optical data ²⁾							
Max. range	15 m						
Emitter	Infrared-LED, 875 nm, pulsed						
Aperture angle at 3 m	typ. +/-14 °	typ. +/-8 °					
Electrical data ²⁾							
Supply voltage U_s	1030 VDC						
Allowable ripple	+/- 10% of U _s						
Current consumption (without load)	< 15 mA	< 8 mA					
Max. load current I _L		100 mA					
Residual voltage		< 1.6 V					
Max. switching frequency		200 Hz					
<i>Test input</i> : emitter on emitter off	\geq 7 V open or \leq 3 V						
Environmental data							
Sealing (Sensor)	IP 67						
Light immunity		> 75`000 Lux @ > 3 ° > 100`000 Lux @ > 15 ° Angle incidence					
Temperature T_A (operating / storage)		-40+70 °C / -25+65 °C					
Weight (cable / connector)	ca. 50 g / 10 g						

1) For product designation of sensors with options see designation code 2) When not otherwise noted, all technical data at $T_A = 25$ °C, $U_S = 24$ V.

Note:

The emitter is only activated, if the *test input* is connected to $\rm U_{\rm s}$ or to a corresponding test signal.

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NPN / PNP light-on or dark-on output

Optical diagrams

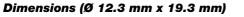


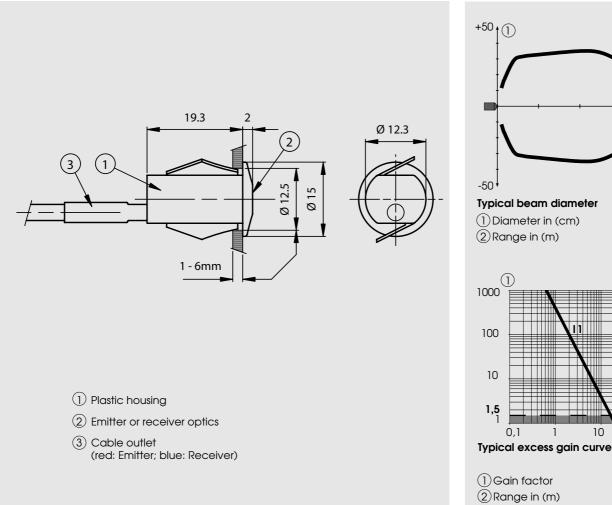
15 m

2

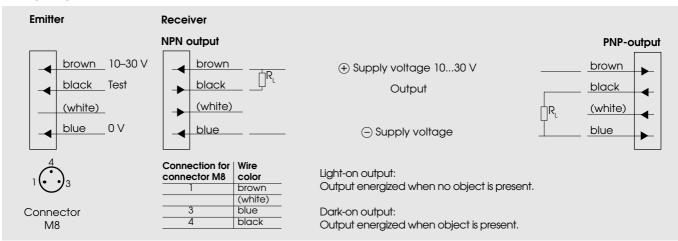
100

15 m





Wiring diagram



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